Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V_{RRM} V_{RWM} V_R	75	V
RMS Reverse Voltage		$V_{R(RMS)}$	53	V
Forward Continuous Current (Note 5)		I_{FM}	300	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I_{FSM}	2.0 1.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Power Dissipation (Note 5)	P_D	350	mW
Typical Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	357	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	75	—	V	I_R = 2.5μA
Forward Voltage	V_F	—	0.715 0.855 1.0 1.25	V	I_F = 1.0mA I_F = 10mA I_F = 50mA I_F = 150mA
Reverse Current (Note 6)	I_R	—	2.5 50 30 25	μA μA μA nA	V_R = 75V V_R = 75V, T_J = +150°C V_R = 25V, T_J = +150°C V_R = 20V
Total Capacitance	C_T	—	2.0	pF	V_R = 0, f = 1.0MHz
Reverse Recovery Time	t_{RR}	—	4.0	ns	I_F = I_R = 10mA, I_{RR} = 0.1 x I_R, R_L = 100Ω

Notes: 5. Part mounted on FR-4 substrate PC board with 1inch squared, 2oz copper pad layout.
6. Short duration pulse test used to minimize self-heating effect.

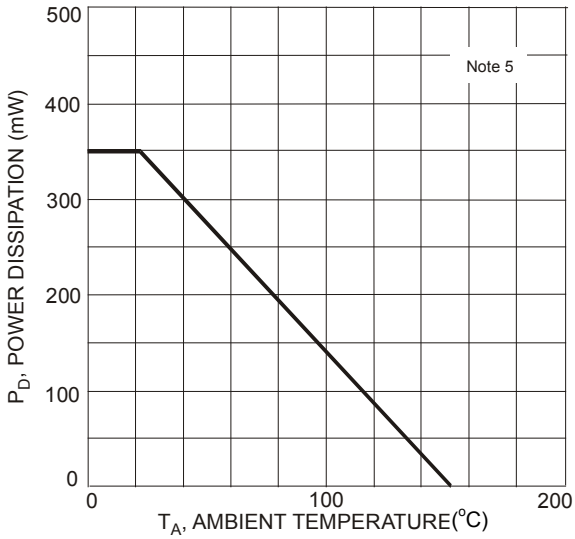

Fig. 1 Power Derating Curve, Total Package

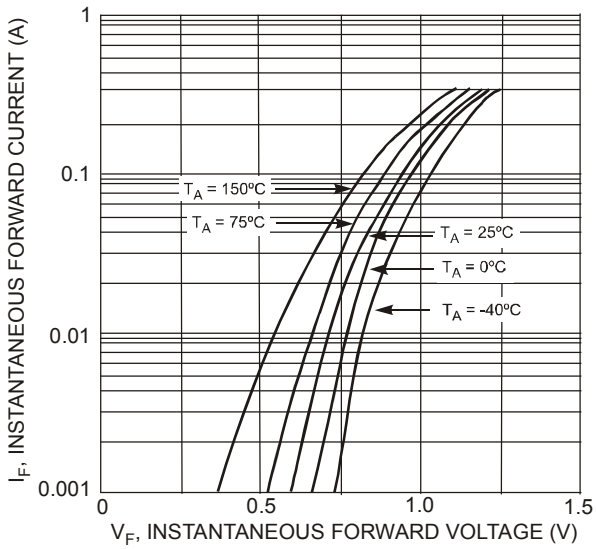

Fig. 2 Typical Forward Characteristics, Per Element

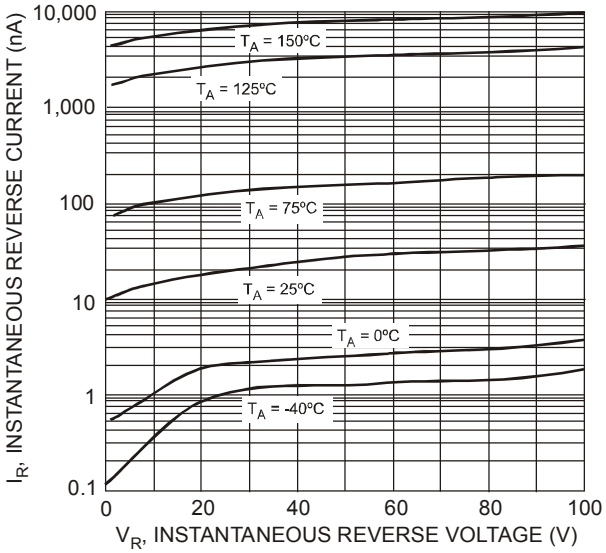

Fig. 3 Typical Reverse Characteristics, Per Element

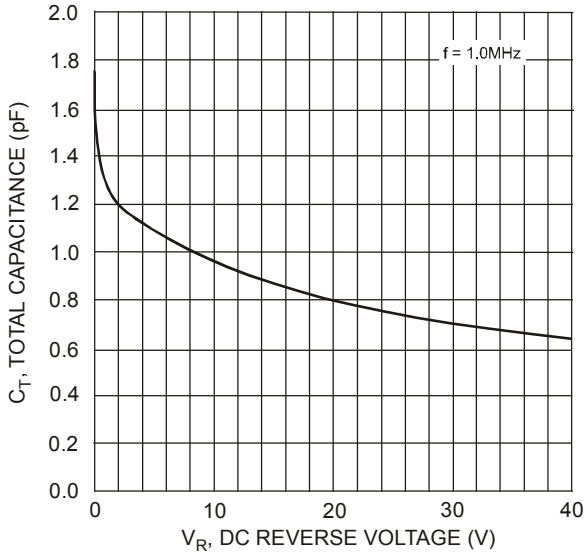

Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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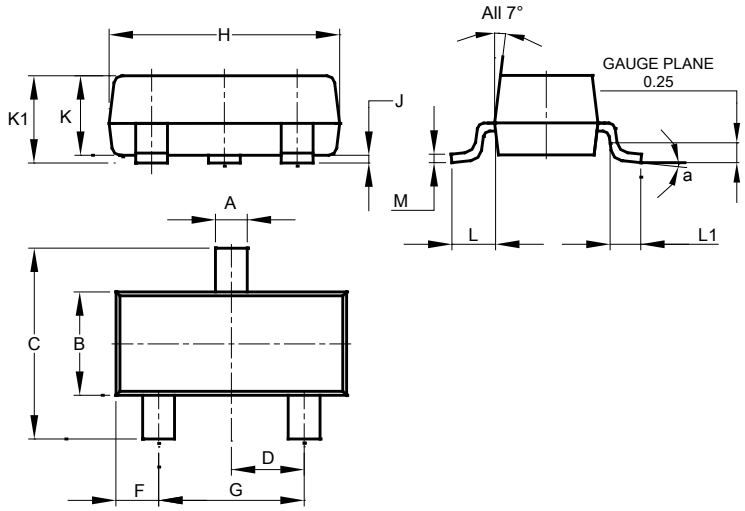
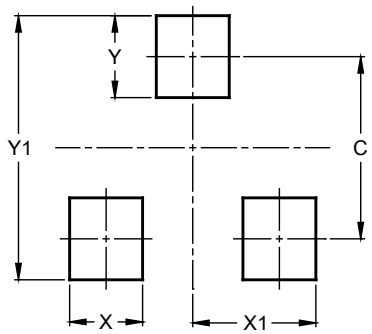


SOT23			
Dim	**Min**	**Max**	**Typ**
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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